

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road, San Jose, CA - 95138

| PRODUCT/PROCESS CHANGE NOTICE (PCN) | | | | | | | |
|--|--|--|---|------------------------|--|--|--|
| PCN #: W19 1 | 11-02 | DATE: 22-Nov-2019 | MEANS OF DISTIN | NGUISHING CHA | NGED DEVICES: | | |
| Product Affected: | : Refer to attachmen | t 2 | ☐ Product Mark ☐ Back Mark ☐ Date Code ■ Other | | e Fab location is the 2 digit sequential te code line of the top | | |
| Date Effective: | 22-Feb-2020 | | | | | | |
| Contact: | IDT PCN DESK | | Attachment: | Yes | ☐ No | | |
| E-mail: idt-pcn@lm.renesas.com | | .com | Samples: Please contact your local sales representative for sample request. | | | | |
| DESCRIPTION | AND PURPOSE OF O | CHANGE: | | | | | |
| □ Die Technology □ Wafer Fabrication Process □ Assembly Process □ Equipment □ Material □ Testing ■ Manufacturing Site □ Data Sheet □ Other | | This notification is to advise our customers that IDT has qualified TSMC Fab 6 as an alternate Foundry for the products listed on this notice. This is to provide additional manufacturing capacity for these products. There is no change to the product design or process technology as the existing qualified Foundry, TSMC Fab 8. There is also no change to the package, backend manufacturing process or the the data sheet. Refer to page 2 for the qualification report. | | | | | |
| | | ualification to date and chara | acterization tests, then | re is no change to the | ne performance or | | |
| IDT records indi to grant approval it will be assume IDT reserves the | l or request additional in d that this change is acc | ritten notification of this chanformation. If IDT does not ceptable. | receive acknowledge | ment within 30 day | s of this notice | | |
| Customer: | | | Approval for s | shipments prior | to effective date. | | |
| Name/Date: | | E- | Mail Address: | | | | |
| Title: | | Pł | none# /Fax# : | | | | |
| CUSTOMER CO | | | _ | | | | |
| | _ | | | | | | |
| | | | | | | | |
| IDT ACKNOWI | LEDGMENT OF REC | CEIPT: | | | | | |
| RECD. BY: | | | DATE: | | | | |



Qualification Report

Product Type: IDTP9242 (Wireless Power Transmitter)

Device Family: AW670T **Process Technology:** CM018BCD, 1P4M

Package Type:NDG40 (QFN)Fab Location:TSMC, Taiwan

| Test Description | Conditions | Sample Size | Reject | Comments |
|---|--|----------------|--------|------------------|
| Device Characterization | IDT's datasheet condition | 35 | 0 | Pass |
| High Temperature Operating Life (Dynamic) | JESD22-A108, +125°C, Vcc-max | 77 x 3 lots | 0 | Pass |
| ESD: Human Body Model | JESD22-A114 (JS-001) Classification (1C, 2KV) | 3 | 0 | Pass |
| ESD: Charged Device Model | JESD22-C101 Classification (C1, 500V) | 3 | 0 | Pass |
| Latch-Up | JESD78 | 3 | 0 | Pass |
| High Temperature Storage Life | JESD22-A103, +150°C | 25 x 3 lots | 0 | Pass |
| Highly Accelerated Temperature and Humidity Stress (Biased) | JESD22-A110, +130°C, 85% R.H., 100 hrs | 25 x 3 lots | 0 | QBS by P12-04-08 |
| Temperature Cycling | JESD22-A104-B (Cond. B -55°C to 125°C) | 77 x 3 lots | 0 | QBS by P12-04-08 |



PRODUCT/PROCESS CHANGE NOTICE (PCN)

ATTACHMENT 2 - PCN # : W1911-02

Affected Part Numbers

| Part Number | Part Number | Part Number | Part Number |
|----------------|---------------|----------------|----------------|
| P9241-G0NDGI | P9242-G0NDGI | P9242-G6NDGI | P9242-GNDGI |
| P9241-G0NDGI8 | P9242-G0NDGI8 | P9242-G6NDGI8 | P9242-GNDGI8 |
| P9241-G1NDGI | P9242-G1NDGI | P9242-G7NDGI | P9243-G1NDGI |
| P9241-G1NDGI8 | P9242-G1NDGI8 | P9242-G7NDGI8 | P9243-G1NDGI8 |
| P9241-GB1NDGI | P9242-G2NDGI | P9242-G8NDGI | P9243-GBNDGI |
| P9241-GB1NDGI8 | P9242-G2NDGI8 | P9242-G8NDGI8 | P9243-GBNDGI8 |
| P9241-GBNDGI | P9242-G3NDGI | P9242-G9NDGI | P9243-G-EVK |
| P9241-GBNDGI8 | P9242-G3NDGI8 | P9242-G9NDGI8 | P9243-G-EVKSMP |
| P9241-G-EVK | P9242-G4NDGI | P9242-GBNDGI | P9243-GNDGI |
| P9241-G-EVKSMP | P9242-G4NDGI8 | P9242-GBNDGI8 | P9243-GNDGI8 |
| P9241-GNDGI | P9242-G5NDGI | P9242-G-EVK | |
| P9241-GNDGI8 | P9242-G5NDGI8 | P9242-G-EVKSMP | |